

Integrated circuit with output drivers

Spec

The invention relates to an integrated circuit provided with at least two output drivers without substrate contacts and further provided with at least a core region with a Vssc contact and a periphery region provided with at least one Vssq contact.

Integrated circuits are becoming ever more complicated in the course of time.

- 5 The number of output drivers increases, as does their complexity. To reduce the ground bounce, the number of output drivers per Vddq/Vssq contact pair (Vddq and Vssq being the supply voltage contact and the ground contact, respectively, of the periphery) must remain limited. Output drivers cause a considerable amount of ground bounce. To prevent this ground bounce propagating through the substrate to other regions, output drivers without substrate
- 10 contacts were developed. The absence of substrate contacts of the output drivers implies that a capacitance will be present between each Vssq contact and the Vssc contact (Vssc is the ground contact of the core). If several different Vddq/Vssq pairs are used, said capacitance will cause a high capacitive coupling between Vssq and Vssc, and noise will appear at Vssc. Another side effect is that resonance is caused by the capacitance, the inductance of the
- 15 connection pins, and the lateral resistance between the N-well and the substrate. This resonance may assume values which rise to above the value present at Vssq.

It is an object of the invention to reduce the ground bounce and the resonances at the Vssc contact if the integrated circuit has two or more output drivers without substrate contacts.

- 20 According to the invention, this object is achieved in that a resistance with a value lying between 100 and 300 ohms is present between each Vssq contact and the Vssc contact.

- Two types of output drivers are known, i.e. drivers which are slew-rate controlled and which are not slew-rate controlled. Slew-rate controlled output drivers limit the di/dt at the output of the output driver and for this reason alone will reduce the ground bounce.
- 25 Drivers which are not slew-rate controlled are to be used only where high speeds are required. Each output driver will contribute to a capacitance to the substrate. The smaller the number of output drivers, the smaller the total capacitance and the smaller the coupling to the substrate. The ground bounce will be limited if a small number of output drivers and supply voltage

pairs V_{ddq}/V_{dds} is used. Resonance, however, will always be present. The resonance may be damped by means of a parallel resistance between each V_{ssq} contact and the V_{ssc} contact.

5 The invention will now be discussed in more detail with reference to the accompanying drawings, in which:

Fig. 1 is a simple model of an output driver with supply voltage contacts and a load;

Fig. 2 shows signal diagrams a and b for comparing the ground bounce and the
10 resonance between a situation without and a situation with an added resistance;

Fig. 3 shows signal diagrams a and b for comparing the ground bounce and the resonance between a situation without and a situation with an added resistance;

Fig. 4 shows signal diagrams a and b for comparing the ground bounce and the resonance between a situation without and a situation with an added resistance;

Fig. 5 shows signal diagrams a and b for comparing the ground bounce and the
15 resonance between a situation without and a situation with an added resistance;

Fig. 6 shows signal diagrams a, b, and c for comparing the ground bounce and the resonance for different supply voltage pairs V_{ddq}/V_{dds} , all with an added resistance.

20 Fig. 1 shows a circuit 1 with a core region 2 and a periphery region 3 in a simplified diagrammatic form. An output driver such as the standard inverter referenced 4 in Fig. 1 is provided in the periphery region and is supplied with a supply voltage via contacts V_{ddq} 5 and V_{ssq} 6. A V_{ssc} contact 7 is present in the core region. Both the V_{ssc} contact 7 and the V_{ssq} contact 6 show a parasitic inductance, 8 and 9, respectively. The output driver is constructed without substrate contacts, which has the result that a capacitor 10 is present between the V_{ssc} contact 7 and the V_{ssq} contact 6. The output driver 4 may either be slew-rate controlled or not slew-rate controlled. The connection pins of the contacts 6 and 7 show a self-inductance which is referenced 8 and 9, respectively. Fig. 1 shows a V_{ddq}/V_{ssq} pair 5, 6.
25 An integrated circuit nowadays comprises more than one such pair. Fig. 1 further shows an output driver 4 belonging to the V_{ddq}/V_{ssq} pair 5, 6. The number of output drivers 4 per V_{ddq}/V_{ssq} pair may also be greater than one. Finally, the number of supply voltage pair connections for the core, referenced V_{ddc}/V_{ssc} 13, 7, may be greater than one. The ground bounce and resonance are indicated with the broken-line circles 14 and 15, respectively. The

number of output drivers and the number of supply voltage pairs determine the size of the capacitor 10 as well as the resonance frequency. The Q factor of the model shown in Fig. 1 can be written as :

$$Q = (R/n) \{ (C_{\text{buf}} \cdot n \cdot m) / [(L_{\text{vssc}}/c) + (L_{\text{vssq}}/n)] \}^{1/2}$$

in which n is the number of pairs Vddq/Vssq, m the number of output drivers per Vddq/Vssq pair, c the number of Vddc/Vssc pairs, Lvssc the inductance 9, Lvssq the inductance 8, C_{buf} the capacitance of the capacitor 10, and R the resistance value of the lateral resistor between the NMOS source contact and the substrate (in the mega-ohm order of magnitude). References not yet defined have the following meanings herein. Vddc is the supply voltage connection of the core, Lvssc is the inductance of the ground connection of the core, and Lvssq is the inductance of the ground connection of the periphery. The greater the value of Q, the higher the peak value of the ground bounce and the longer it takes before the resonance has died down. It was found that the value of Q can be substantially reduced and accordingly the peak value of the ground bounce and the duration of the resonance can be considerably reduced if a resistance, referenced 11 in Fig. 1, is provided between the Vssq contact 6 and the Vssc contact 7, in particular if this resistance has a value of between 100 and 300 ohms.

The value of the resistance 11 may be determined with greater exactitude if a distinction is made between output drivers which are and output drivers which are not slew-rate controlled. The resistance R 11 should preferably have a value of between 100 and 250 ohms for output drivers 4 which are slew-rate controlled. The resistance R 11 should preferably have a value of between 250 and 300 ohms for output drivers 4 which are not slew-rate controlled.

In Fig. 2, time is plotted on the horizontal axis in units of 10 nanoseconds and voltage on the vertical axis in units of 50 millivolts. The same is true for Figs. 3, 4, 5, and 6, and it will accordingly not be repeated for these Figures.

Fig. 2a shows the situation in which no resistance 11 was provided between the Vssq and Vssc contacts in a circuit with output drivers which are not slew-rate controlled, in an integrated circuit with one Vddc/Vssc pair, one Vddq/Vssq pair, and three output drivers which are not slew-rate controlled. The situation is shown in particular where all three not slew-rate controlled output drivers switch simultaneously, which leads to the maximum ground bounce for the relevant integrated circuit. Fig. 2a shows the situation without a resistance 11, and Fig. 2b shows the situation in which a resistance of 100 ohms is provided. It

is clearly apparent that both the ground bounce and the resonance have been substantially reduced.

Fig. 3 shows the results of the provision of the resistance 11 in an integrated circuit with three slew-rate controlled output drivers, all three switching simultaneously, while one V_{ddc}/V_{ssc} pair and one V_{ddq}/V_{ssq} pair are present, as in Fig. 2. The value of the resistance 11 in this case is 100 ohms. Here again, the addition of the resistance 11 is found to lead to a substantial reduction in the ground bounce and the resonance.

A situation is sketched in Fig. 4 which is comparable to that of Fig. 3. It relates again to an integrated circuit with one V_{ddc}/V_{ssc} pair and one V_{ddq}/V_{ssq} pair, but now with nine slew-rate controlled output drivers which all nine switch simultaneously. Again, a substantial reduction in the ground bounce and the resonance is found to occur.

Fig. 5 relates to the same integrated circuit as Fig. 4; however, only three of the nine slew-rate controlled output drivers are switching. It is clearly apparent from Fig. 5 that the peak value of the ground bounce is determined by the number of switching output drivers, while the output drivers which do not switch do contribute to the total capacitance, with the result that the resonance is damped less quickly. The large influence of the provision of the resistance 11, in this case with a value of 100 ohms, on the amplitude of the ground bounce and the duration of the resonance is evident again from Fig. 5.

Fig. 6 indicates for three cases what is the influence of the number of output drivers per V_{ddq}/V_{ssq} pair. Each of the Figs. 6a, 6b, and 6c, relates to an integrated circuit with six output drivers which switch all six simultaneously. A resistance 11 is also provided in all three cases. Fig. 6a shows the situation in which all six output drivers are supplied by means of one V_{ddq}/V_{ssq} pair. Fig. 6b shows the situation in which all six output drivers are supplied by means of two V_{ddq}/V_{ssq} pairs. Fig. 6c shows the situation in which all six output drivers are supplied by means of four V_{ddq}/V_{ssq} pairs. It is apparent from Fig. 6 that the distribution of a given number of output drivers over several V_{ddq}/V_{ssq} pairs does have some, albeit small, influence on the amplitude of the ground bounce and the resonance, but definitely much less than the mere addition of the resistance 11.

Various embodiments and modifications will now suggest themselves to those skilled in the art in view of the above. All such embodiments and modifications are deemed to fall within the scope of the invention.